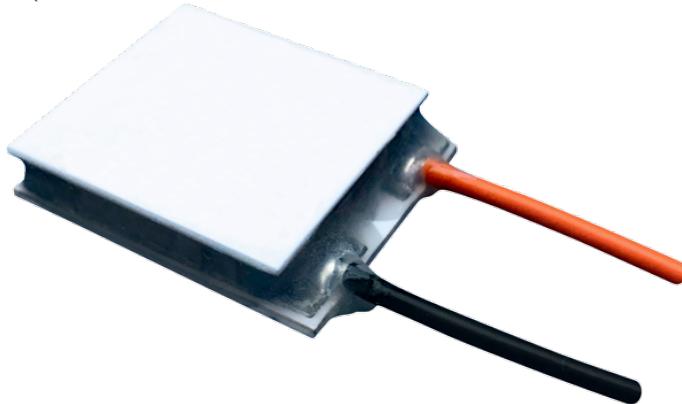


HiTemp ETX Series Thermolectric Cooler

The ETX9-3-F2-2525-TA-W6 high temperature, high-performance thermoelectric cooler uses Laird Thermal Systems' enhanced thermoelectric module construction preventing performance degrading diffusion, which is common in standard grade thermoelectric coolers operating in high temperature environments exceeding 80 °C. It has a maximum Q_c of 23.6 Watts when $\Delta T = 0$ and a maximum ΔT of 83.2 °C at $Q_c = 0$.

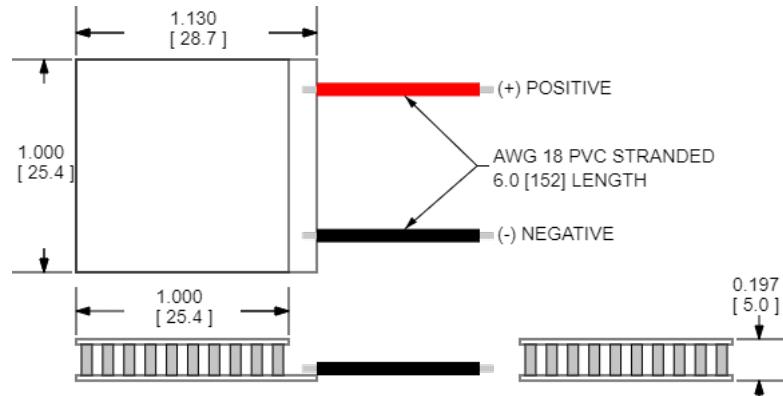


Features

- High-temperature operation
- Reliable solid-state
- No sound or vibration
- Environmentally-friendly
- RoHS-compliant

Applications

- Peltier Cooling for Refrigerated Centrifuges
- Peltier Cooling for Machine Vision
- Thermoelectric Cooling for CMOS Sensors
- Cooling Solutions for Autonomous Systems
- Peltier Cooling for Digital Light Processors
- Heating and Cooling for Liquid Chromatography Systems
- Thermoelectric Cooling for Security Cameras



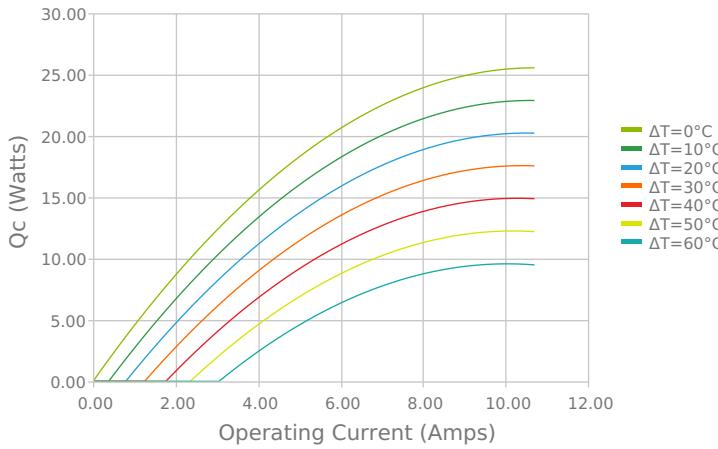
CERAMIC MATERIAL: Al_2O_3

SOLDER CONSTRUCTION: 232°C, SbSn

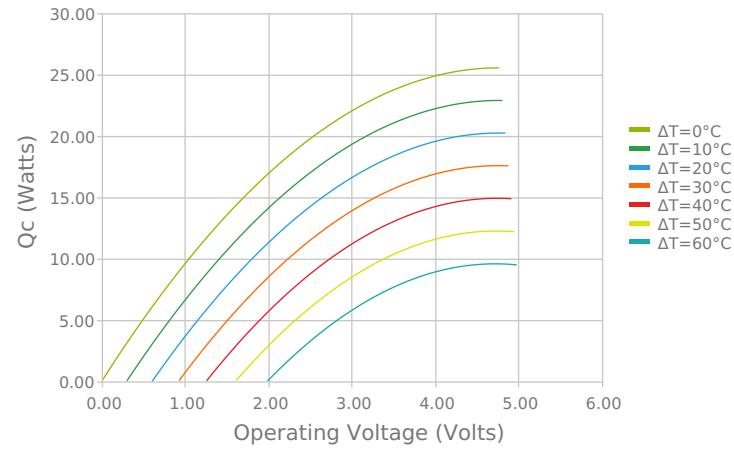
INCHES [MM]

ELECTRICAL AND THERMAL PERFORMANCE

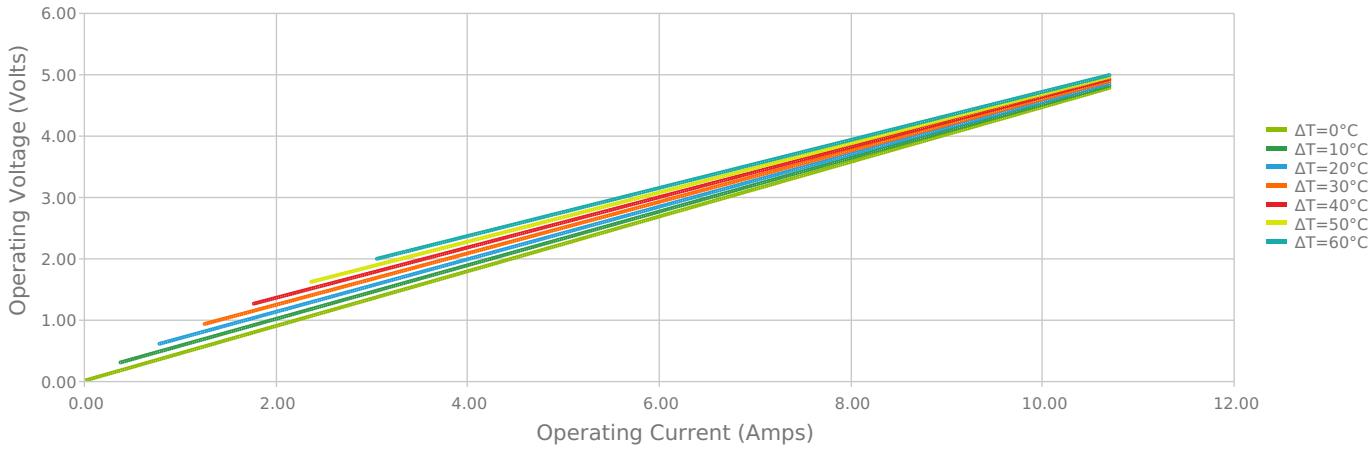
Heat Pumped at Cold Side
 $T_{\text{hot}} = 85^\circ\text{C}$



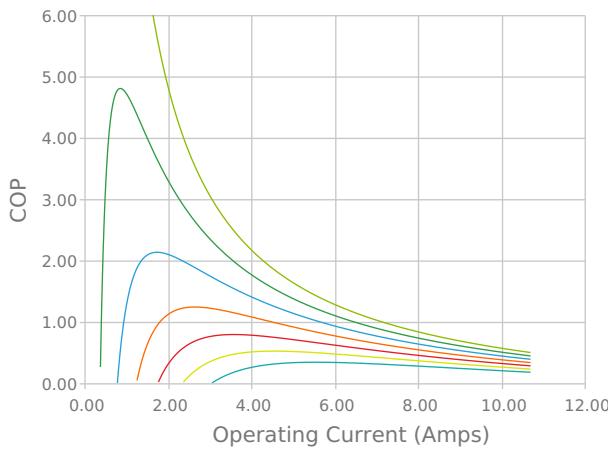
Heat Pumped at Cold Side
 $T_{\text{hot}} = 85^\circ\text{C}$



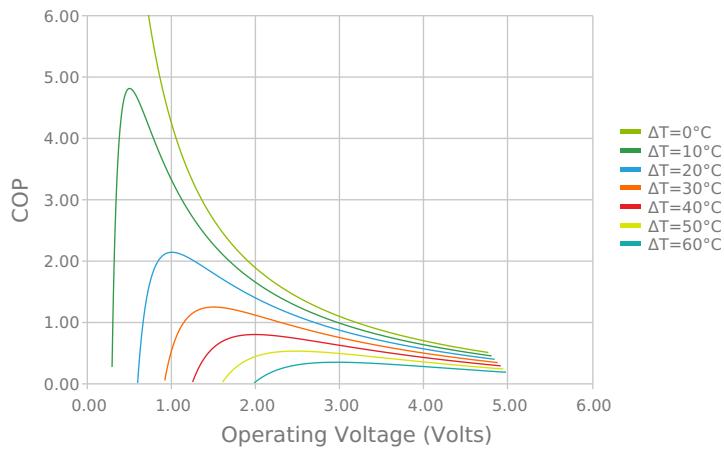
Current vs Voltage (I vs V)
 $T_{\text{hot}} = 85^\circ\text{C}$



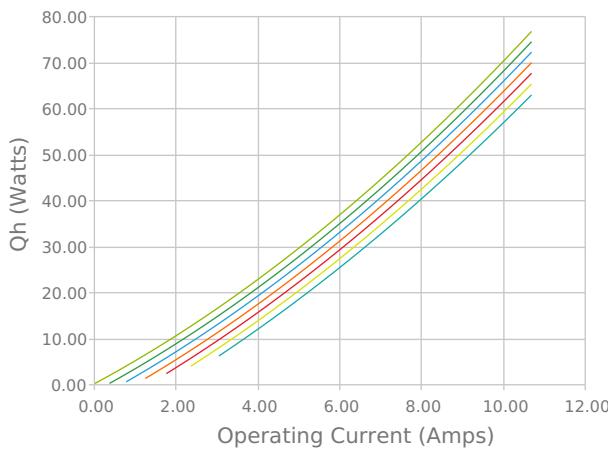
Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 85^\circ\text{C}$



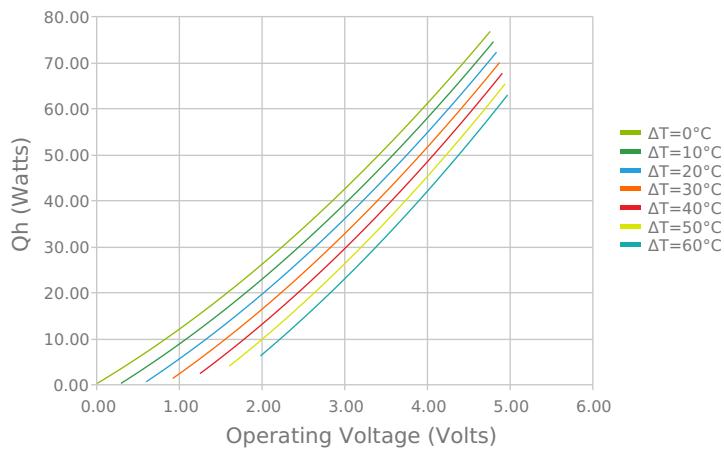
Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 85^\circ\text{C}$



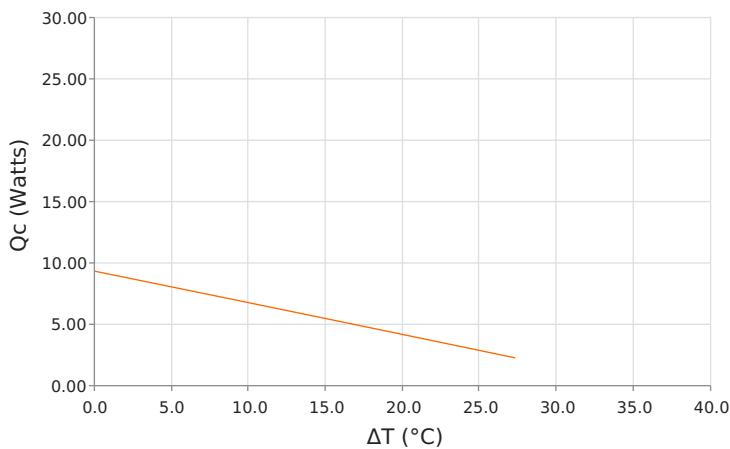
Total Heat Dissipated at Hot Side ($Q_h = Q_c + P_{in}$)
 $T_{hot} = 85^\circ\text{C}$



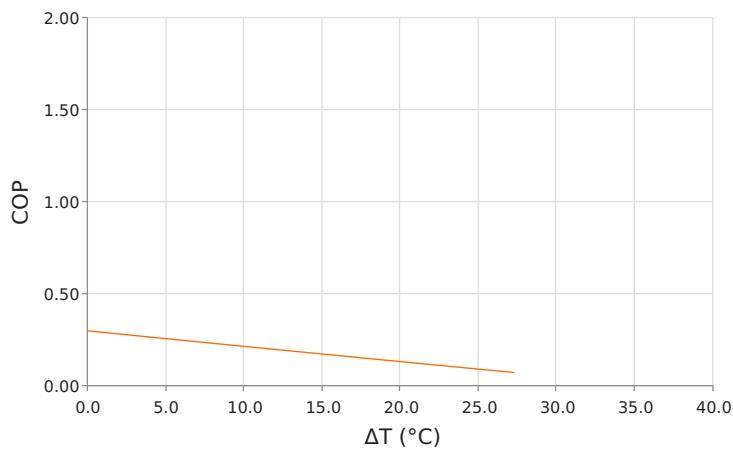
Total Heat Dissipated at Hot Side ($Q_h = Q_c + P_{in}$)
 $T_{hot} = 85^\circ\text{C}$



Heat Pumped at Cold Side (Q_c)
 $T_{hot} = 85^\circ\text{C}$ | Current = 8.0 Amps



Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 85^\circ\text{C}$ | Current = 8.0 Amps



SPECIFICATIONS*

	50.0 °C	85.0 °C	110.0 °C
Qcmax (ΔT = 0)	23.6 Watts	25.5 Watts	26.3 Watts
ΔTmax (Qc = 0)	83.2°C	95.3°C	102.0°C
I_{max} (I @ ΔT_{max})	9.9 Amps	9.5 Amps	9.3 Amps
V_{max} (V @ ΔT_{max})	4.1 Volts	4.7 Volts	5.1 Volts
Module Resistance	0.38 Ohms	0.45 Ohms	0.49 Ohms
Max Operating Temperature	150 °C		
Weight	17.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
TA	5.004 ±0.025 mm 0.197 ± 0.0010 in	0.025 mm / 0.025 mm 0.001 in / 0.001 in	Lapped	Lapped	152.4 mm 6.00 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
	None			No sealing specified

NOTES

1. Max operating temperature: 150°C
2. Do not exceed I_{max} or V_{max} when operating module
3. Reference assembly guidelines for recommended installation

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Date: 12/14/2021